

PulseForge Receives 2024 3D InCites Technology Enablement Award for Photonic Debonding

PulseForge is thrilled to announce its receipt of the esteemed 2024 3D InCites Technology Enablement Award for its revolutionary Photonic Debonding technology.

AUSTIN, TEXAS, UNITED STATES, April 15, 2024 /EINPresswire.com/ -- PulseForge, a pioneer in advanced packaging solutions, is thrilled to announce its receipt of the esteemed 2024 [3D InCites](#) Technology Enablement Award for its revolutionary [Photonic Debonding](#) technology. The award was presented at the [IMAPS](#) Device Packing Conference in Fountain Hills, AZ, on March 19, 2024.

PulseForge's Photonic Debonding technology was recognized for its outstanding innovation and its transformative impact on the semiconductor industry. Dr. Harry Chou, a Senior Application Engineer at PulseForge, accepted the award on behalf of the company from Thomas Uhrmann of EV Group, a Platinum Sponsor of IMAPS DPC 2024.

Jonathan Gibson, CEO of PulseForge, expressed his gratitude for the recognition, stating, "We are honored to receive the 2024 3D InCites Technology Enablement Award for our Photonic Debonding technology. This award is a testament to the dedication and



2024 3D InCites Technology Enablement Award



Dr. Harry Chou of PulseForge Inc receiving the award from Dr. Thomas Uhrmann of EVG at IMAPS DPC 2024

expertise of our team. Our Photonic Debonding Technology has garnered significant interest from industry leaders, and we are excited to continue working with our customers as we integrate Photonic Debonding into their high-volume manufacturing operations."

Photonic Debonding technology offers a cost-effective alternative to existing industry methods. A key breakthrough of this technology is its innovative use of a reusable inorganic light absorbing layer, ensuring an improved yield and a clean debonding process. Additionally, Photonic Debonding can process wafers at a substantially higher throughput than other industry alternatives.

For more information about PulseForge and its Photonic Debonding technology, please visit www.pulseforge.com/Debonding

Contact:

Vikram Turkani, Director, Technology Partnerships and Strategic Business Development

Email: vikram.turkani@pulseforge.com

Phone: +1 269-743-8168

About PulseForge:

PulseForge, Inc. utilizes applied energy in a precise and targeted manner to enable innovation in industrial manufacturing. Our expertise and tools empower our customers to explore novel materials and manufacturing methodologies, driving dynamic and efficient production at an industrial scale

About 3D InCites

3D InCites is an online media resource founded in 2009 in an effort to stir up interest in 3D integration and heterogeneous integration technologies

Vikram Turkani

PulseForge, Inc.

+1 269-743-8168

vikram.turkani@pulseforge.com

Visit us on social media:

[LinkedIn](#)

This press release can be viewed online at: <https://www.einpresswire.com/article/703849097>

EIN Presswire's priority is source transparency. We do not allow opaque clients, and our editors try to be careful about weeding out false and misleading content. As a user, if you see something we have missed, please do bring it to our attention. Your help is welcome. EIN Presswire, Everyone's Internet News Presswire™, tries to define some of the boundaries that are reasonable in today's world. Please see our Editorial Guidelines for more information.

© 1995-2024 Newsmatics Inc. All Right Reserved.